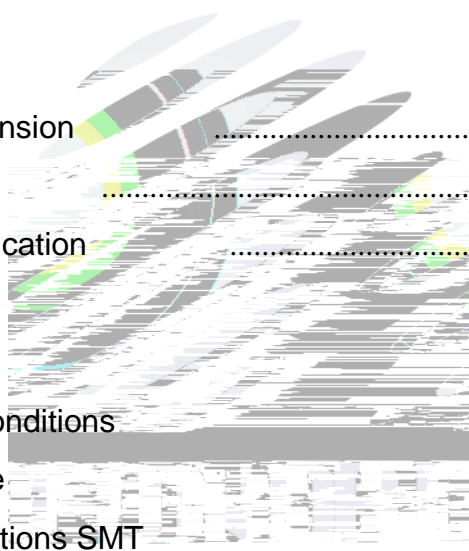


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4.1 Handling Precautions	



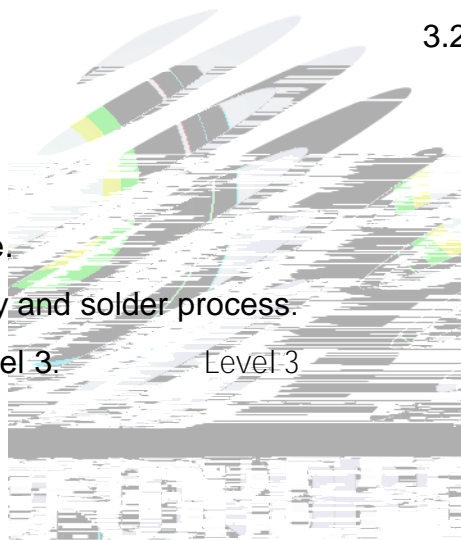
1. Description

1.1 General Description

The Colour LED which was fabricated using a yellow chip Package Dimension :
3.2mmX1.25mmX1.1mm.

LED

3.2mmX1.25mmX1.1mm



1.2 Features

Extremely wide viewing angle.

Suitable for all SMT assembly and solder process.

Moisture sensitivity level: Level 3.

RoHS compliant. RoHS

SMT

Level 3

1.3 Application

Optical indicator.

Switch and symbol, display

TEL: +86-755-66839118 FAX: +86-755-66839300 E-mail: sales@refond.com Web: www.refond.com P115 (P / P) UTS1 242.33 564.07Tm (o) 12P 603013 (, 9 (R) 1 (P) BT/B 9.96 Tf 0 0 1 31711C38



1.4 Package Dimension

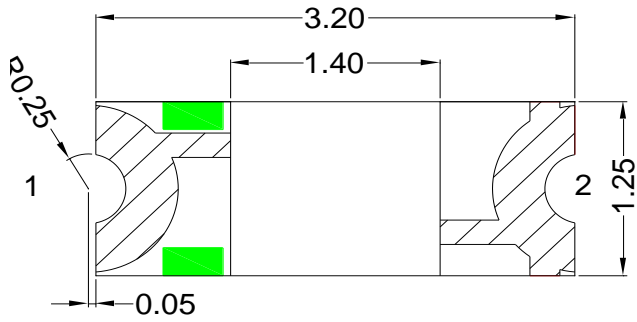


Fig.1-1 Top view

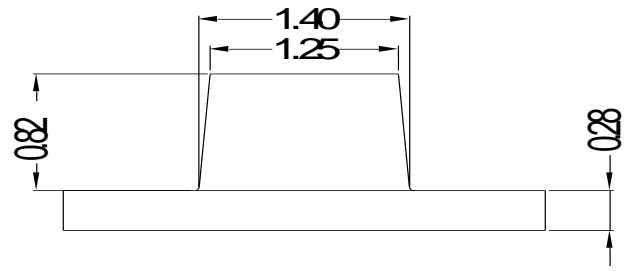


Fig.1-2 Side view

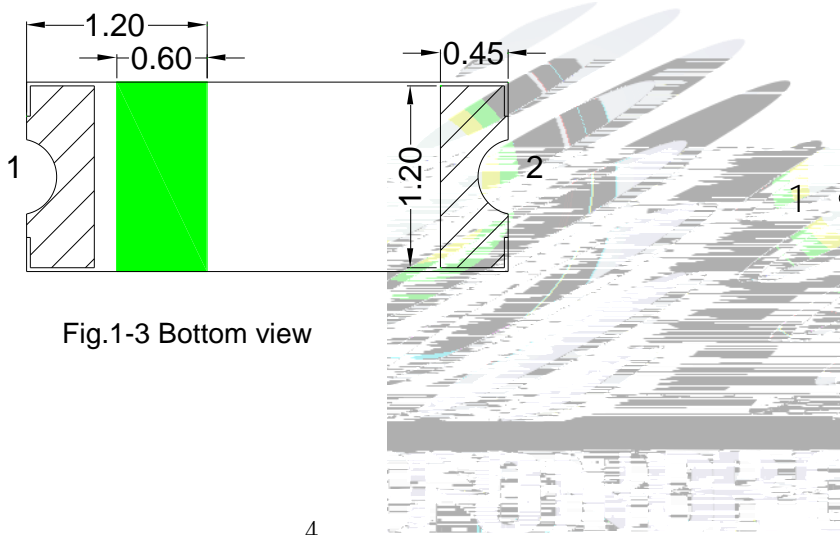


Fig.1-3 Bottom view

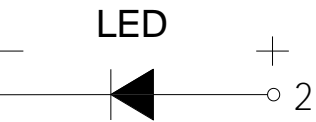


Fig.1-4 Polarity

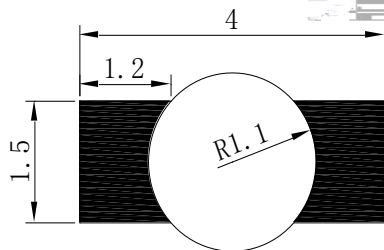


Fig.1-5 Soldering patterns

Notes

1. All dimensions units are millimeters.

All dimensions tolerances are ± 0.2 mm unless otherwise noted.



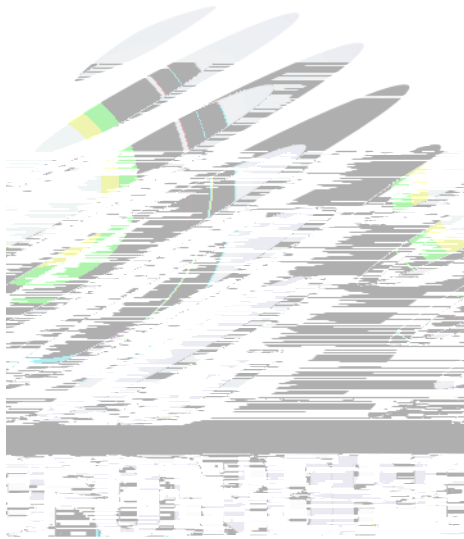


Table 1-2 Absolute Maximum Ratings at Ts=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	P_d	84	mW
Forward Current	I_F	30	mA
Peak Forward Current Of Pulse	I_{FP}	60	mA
Electrostatic Discharge (HBM)	E_{SD}	2000	V
Operating Temperature	T_{opr}	-40 ~ +85	
Storage Temperature	T_{stg}	-40 ~ +85	
Junction Temperature	T_j	95	

Notes

- 1/10 Duty cycle, 0.1ms pulse width. 0.1ms, 1/10.
- The above forward voltage measurement allowance tolerance is $\pm 0.1V$. $\pm 0.1V$.
- The above dominant wavelength measurement allowance tolerance is $\pm 2nm$. $\pm 2nm$.
- The above luminous intensity measurement allowance tolerance $\pm 10\%$. $\pm 10\%$.
- Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.
- All measurements were made under the standardized environment of Refond.
- When the LEDs are in operation the maximum current should be decided after measuring the package temperature, junction temperature should not exceed the maximum rate. LED



1.6 Typical Optical Characteristics Curves

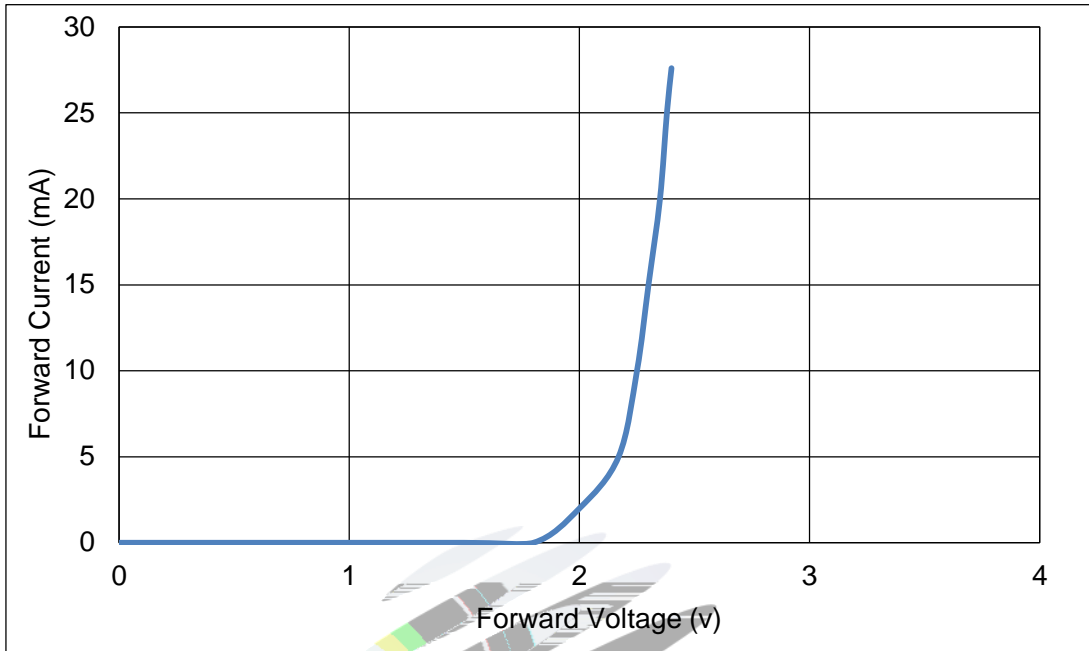


Fig 1-6 Forward Voltage Vs Forward Current

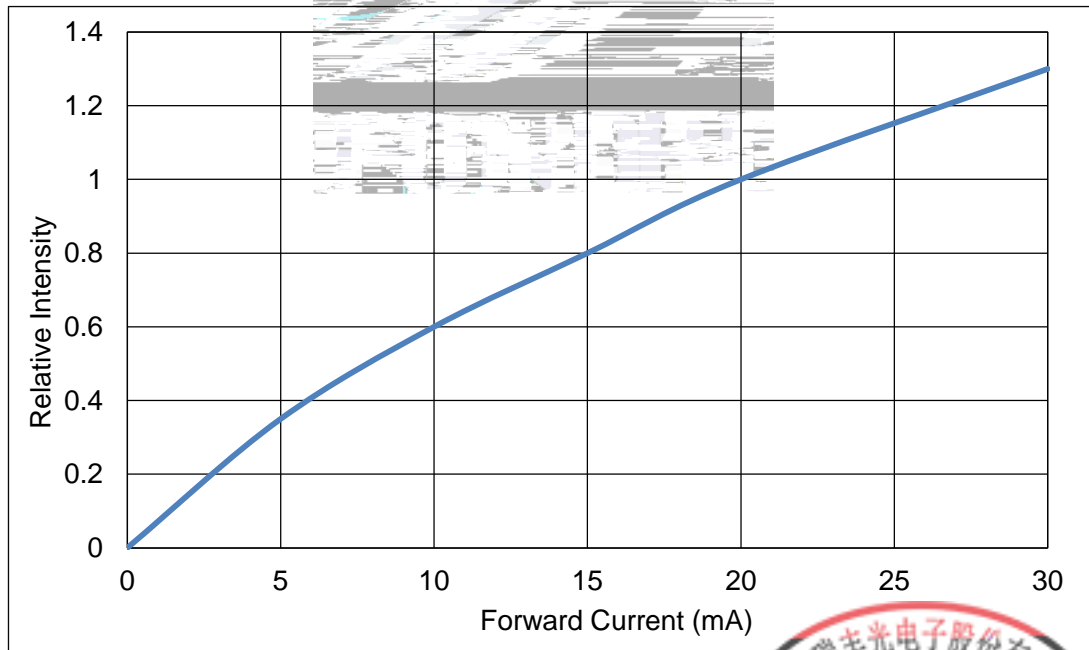
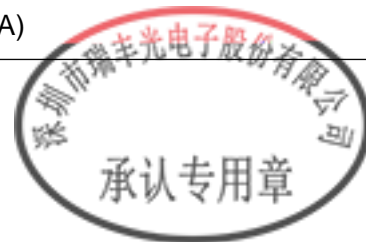


Fig 1-7 Forward Current Vs Relative Intensity



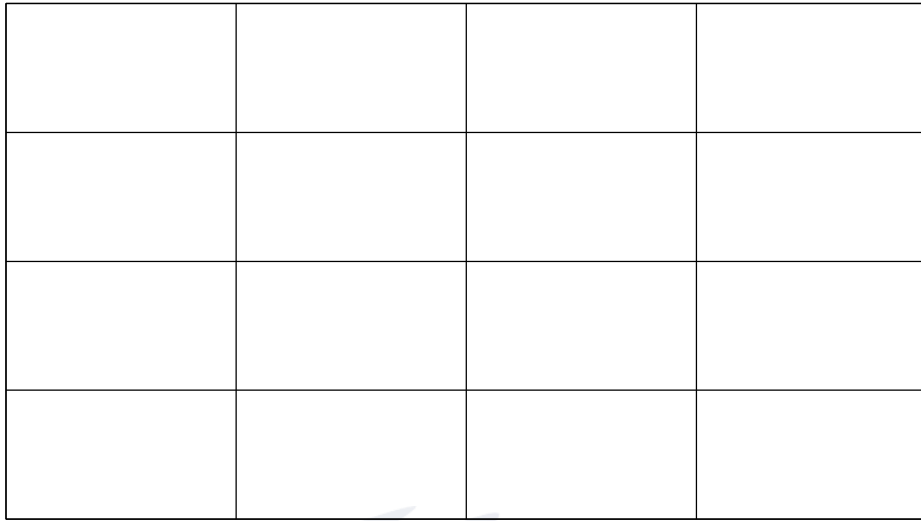


Fig 1-8 Pin Temperature Vs Relative Intensity

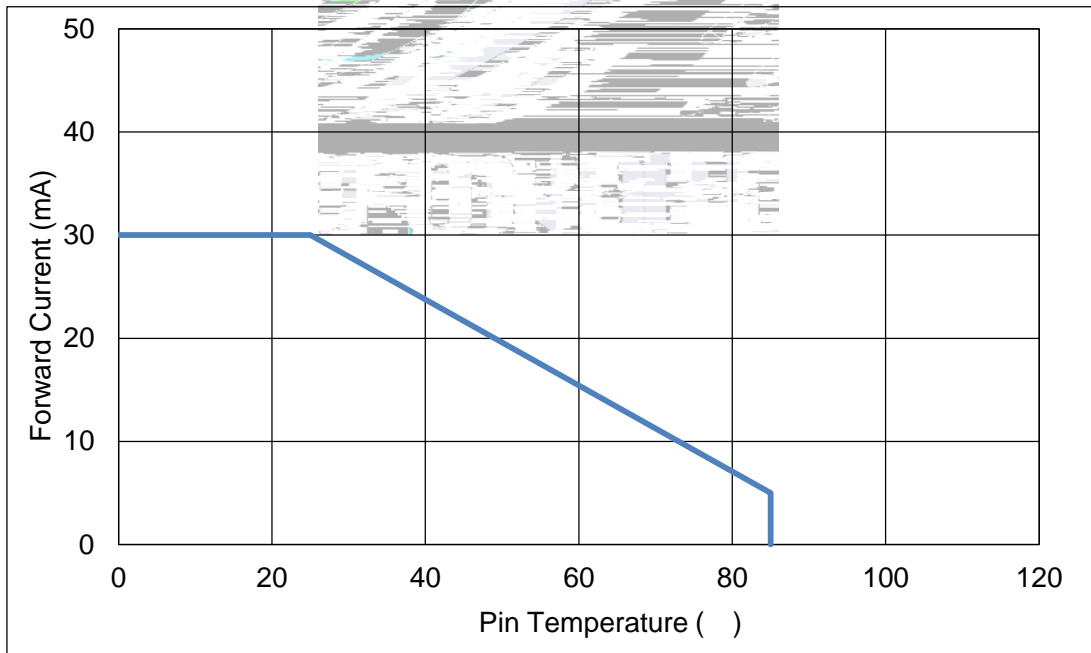


Fig 1-9 Pin Temperature Vs Forward Current

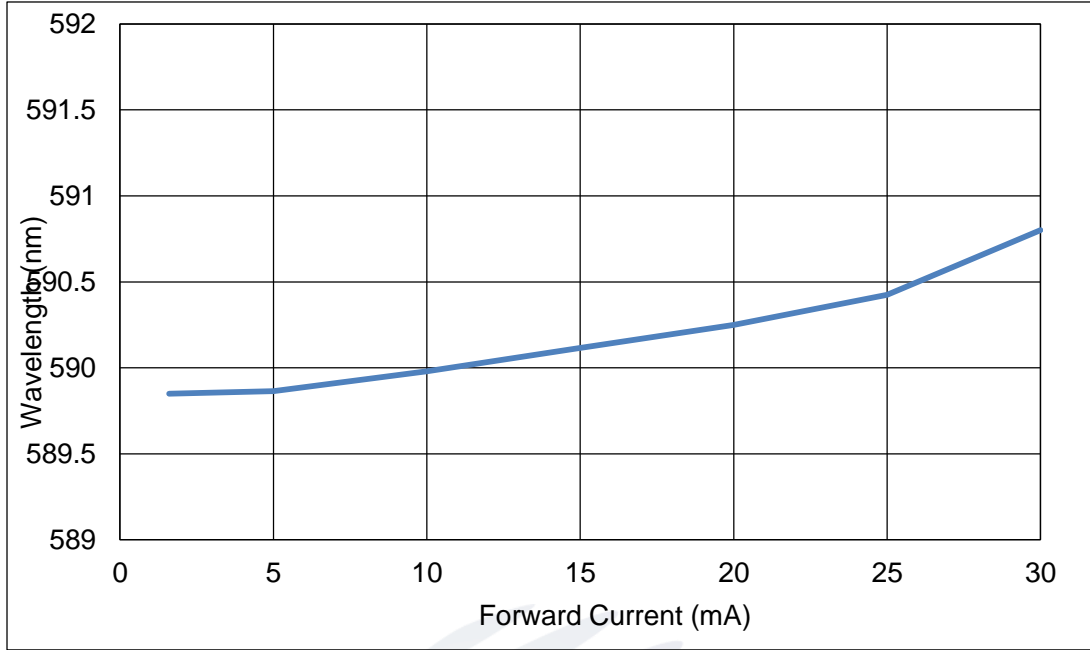


Fig 1-10 Forward Current Vs Dominate Wavelength (Ta=25)

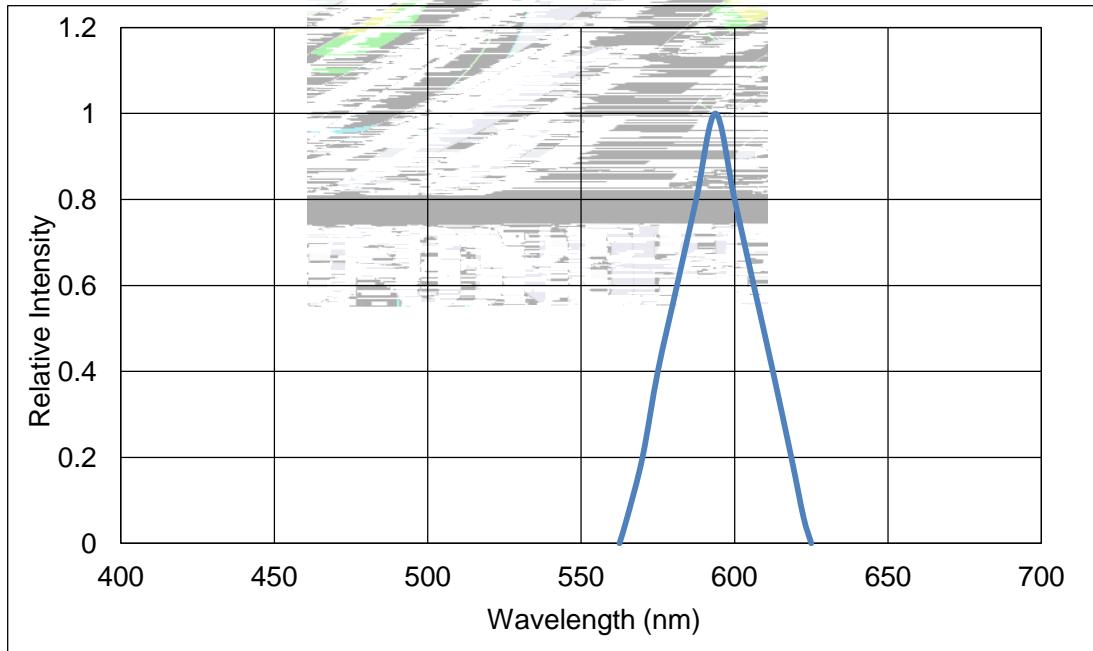
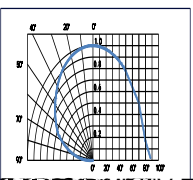


Fig 1-11 Relative Intensity Vs Wavelength (Ta=25)



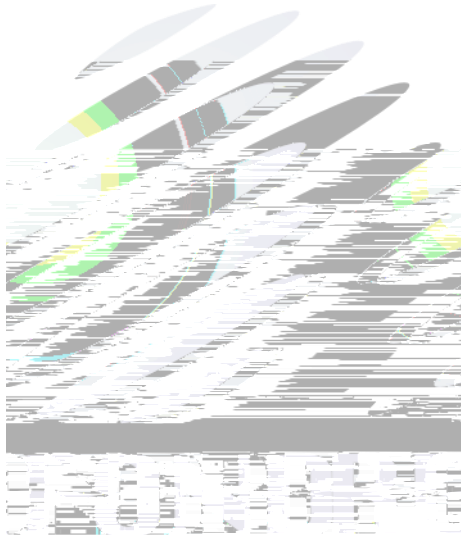


2. Packaging

2.1 Packaging Specification


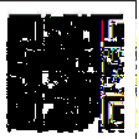
Package:3000pcs/reel. 3000pcs

2.1.1 Carrier Tape Dimension



2.1.3 Label Form Specification

Table 2-2 Parameter

PART NO:		
SPEC NO:		
LOT NO		
BIN CODE:		
Φ:	XY:	
VF:	WLD:	
		
		QTY:
		DATE:

PART NO.	Part Number
SPEC NO.	Spec Number
LOT NO.	Lot Number
BIN CODE	Bin Code
	Luminous flux
XY	Chromaticity Bin
VF	Forward Voltage
WLD	Wavelength
QTY	Packing Quantity
DATE	Made Date

Fig. 2-3 Label Form Specification

2.2 Moisture Resistant Packing

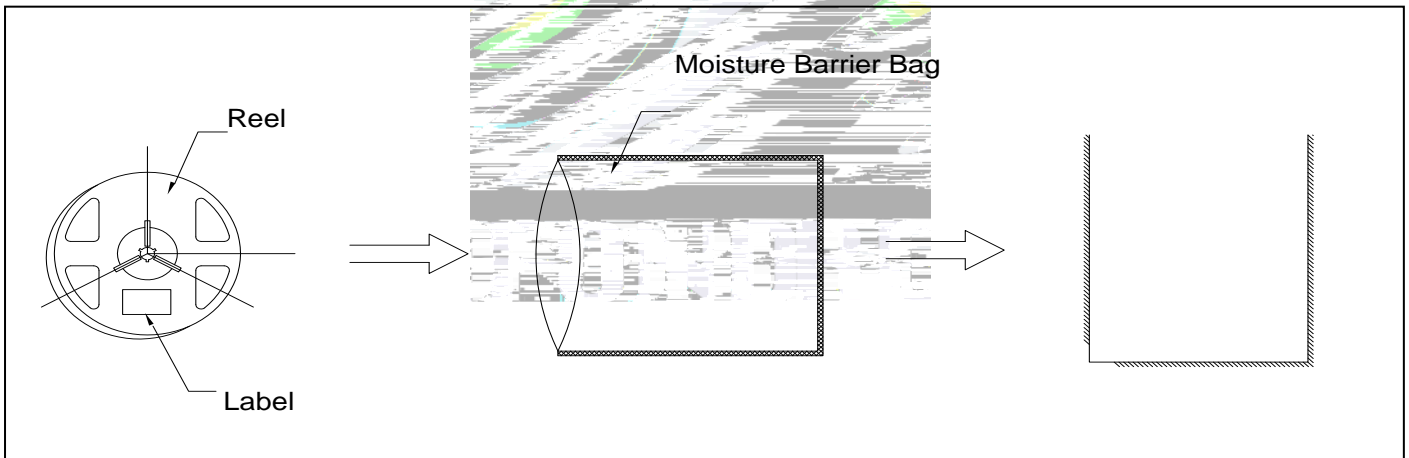


Fig.2-4 Moisture Resistant Packing



2.3 Cardboard Box

Fig.2-5 Cardboard Box

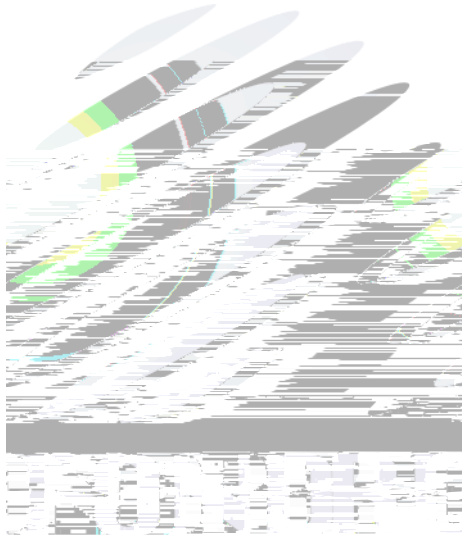
2.4 Reliability Test Items And Conditions

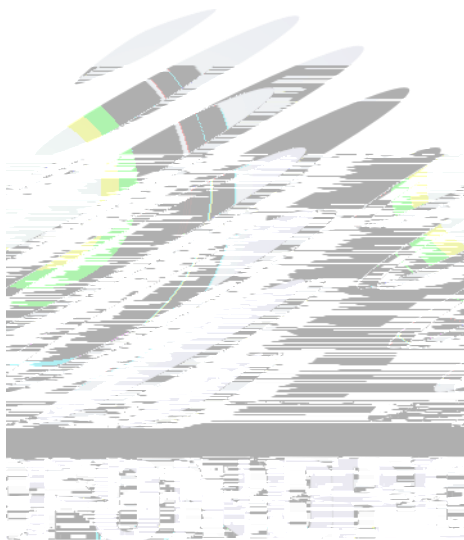
Table 2-3 Reliability Test Items And Conditions

Test Items	Ref.Standard	Test Condition	Time	Quantity	Ac/Re /
Reflow	JESD22-B106	Temp:260 max T=10 sec	2 times	22Pcs.	0/1
Temperature Cycle	JESD22-A104				

3. SMT Reflow Soldering Instructions SMT

3.1





4. Handling Precautions

4.1 Handling Precautions

(1) LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material. This is provided for informational purposes only and is not a warranty or endorsement. LED LED 100PPM.

(2) In order to prevent external material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM, the single content of Chlorine element is required to be less than 900PPM, the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement.

LED LED 900PPM 900PPM 1500PPM.

(3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against the use of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verify compatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor. LED

LED

LED

LED



(4) In designing a circuit, the current through each LED can not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen. The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.

LED

LED

(5) Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color change and so on. Please consider the heat generation of the LEDs when making the system design. LED



(6) Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	30	75%	Within 1 Year From Date
	After Opening Aluminum Bag	30	60%	168hours 168
Baking		60± 5	-	24hours 24

(7) If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time , baking treatment should be performed after unpacking and based on the following condition (60±5) °C for above 24 hours.

60± 5 24

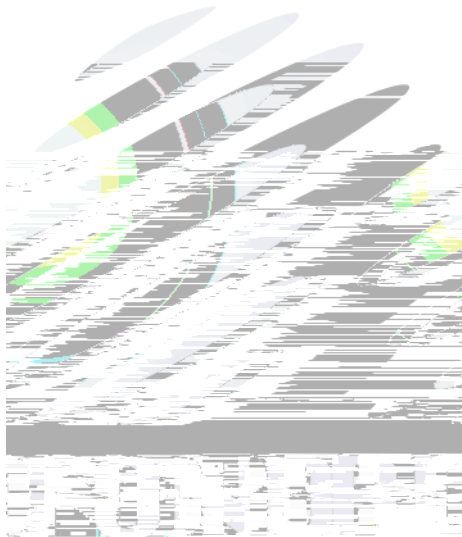
(8) If the package is flatulence or damaged, please notify the sales staff to assist.



(9) Similar to most Solid state devices; LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS).

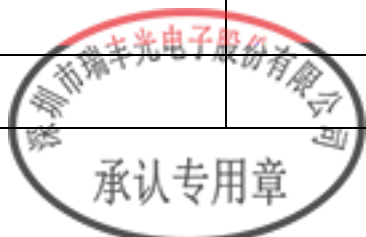
LED

(10) Other points for attention, please refer to our relevant information.



Version History/

Date	Revisor	Version	Verifier	Remarks
2021.03.17		E/0		
2021.06.25		E/1		1
2022.08.30		E/2		





Declare

This specification is written both in English and in Chinese and the latter is formal

